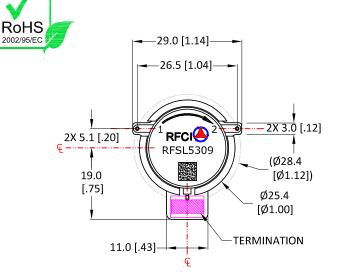
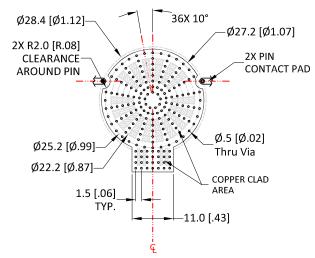


DWG. NO.

REV



ONLY BE INCORPORATED AS DIRECTED BY THE DESIGN ACTIVITY.



–Ø25.4 [1.00]–**-**8.5 [.33] Ø23.5 [.93]-2X PIN SEE FINISH -2X Ø1.2 [.05]

SolderMask Pattern

Recommended Footprint Copper-SolderMask Pattern

The Land Pattern should be with good thermal conductivity

Finish:

- 1. Housing: Silver plated
- 2. Pin: Gold plated
- 3. Coplanarity specification: 0.10 [.004] MAX.

Specifications

| Parameter | Minimum | Typical | Maximum |
|-----------------------|---------|---------|---------|
| Frequency Range (MHz) | 1165 | | 1215 |
| Insertion Loss (dB) | | < .22 | .30 |
| Isolation (dB) | 20 | > 23 | |
| Return Loss (dB) | 22 | > 23 | |

Power & Temperature Ratings

| Parameter | Maximum | |
|---------------------------------|----------------|--|
| Forward PWR Peak/AVG | 500/100 Watts | |
| Reverse Power CW | 80 Watts | |
| Termination Rating (See Note 2) | 100 Watts | |
| Operating Temperature | -40 to +85° C | |
| Storage Temperature | -50 to +125° C | |

NOTES:

- 1. Typical Values Represent Performance @ +23 °C.
- 2. Isolator Flange held to +85°C; 30 Min. maximum Duration.

CW SMD ISOLATOR MODEL: RFSL5309

